

<b>Number of PCBs:</b>	2	<b>Delivery Time:</b>		days	<b>Delivery:</b>	DDU Prague
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<b>PCB Name:</b>	CZ17NIC010000	<b>PCB Dimensions:</b>	68.8 mm	x	53.5 mm	+/-	0.2 mm
<b>Panel Array:</b>	x	<b>Panel Dimensions:</b>	234 mm	x	244 mm	+/-	mm
<b>Separation:</b>	Milling	<b>PCB Thickness:</b>	1.5 mm	+/-	0.05 mm	<b>E-Test:</b>	Yes

<b>Material:</b>	FR4	<b>Min. Tg:</b>	135 °C	<b>Stack-Up:</b>	See Next Page
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<b>Number of Layers:</b>	2	<b>Number of Signal Layers:</b>		<b>Number of planes:</b>	
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<b>Min. Track Width:</b>	300 µm	<b>Min. Annual Ring:</b>	350 µm	<b>Min. Isolation Gap:</b>	300 µm
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<b>Min. Drilled Hole:</b>	0.6 mm	<b>Size of:</b>	Tool	<b>Number of Holes:</b>	153
<b>Min. Laser Hole:</b>	N/A mm	<b>Size of:</b>	N/A	<b>Number of Holes:</b>	N/A

<b>Slot holes:</b>	No	<b>Blind Vias:</b>	No	<b>Burried Vias:</b>	No	<b>Non-Plated Vias:</b>	No
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<b>Filled Vias:</b>	No	<b>Overplated:</b>	N/A	<b>Flat Surface:</b>	N/A	<b>IPC-4761 type:</b>	N/A
<b>Filled µVias:</b>	No	<b>Overplated:</b>	N/A	<b>Flat Surface:</b>	N/A	<b>IPC-4761 type:</b>	N/A

<b>Solder Resist Top:</b>	Green	<b>Silk Screen Top:</b>	White	<b>Removable Mask Top:</b>	No
<b>Solder Resist Bottom:</b>	Green	<b>Silk Screen Bottom:</b>	No	<b>Removable Mask Bottom:</b>	No

<b>Surface Finish:</b>	ENIG	<b>Min. Gold Thickness:</b>	0.07 µm	<b>Hard-Gold Connectors:</b>	No
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<b>Controlled impedance:</b>	No	<b>Requested Coupons from Measurement:</b>	No
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Layer	SE	+/- %	DIFF	+/- %	Ref. Layer 1	Ref. Layer 2	Note

	Layer Name	Type	Material	Thickness (mm)	Dielectric Material	Dielectric Constant	Pullback (mm)	Orientation
	<input checked="" type="checkbox"/> Top Overlay	Overlay						
	<input checked="" type="checkbox"/> Top Solder	Solder Mask/Co...	Surface Material	0.01016	Solder Resist	3.5		
	<input checked="" type="checkbox"/> Top	Signal	Copper	0.035				Top
	<input checked="" type="checkbox"/> Dielectric 1	Dielectric	Core	1.5	FR-4	4.8		
	<input checked="" type="checkbox"/> Bottom	Signal	Copper	0.035				Bottom
	<input checked="" type="checkbox"/> Bottom Solder	Solder Mask/Co...	Surface Material	0.01016	Solder Resist	3.5		
	<input checked="" type="checkbox"/> Bottom Overlay	Overlay						

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Quotation Form  
PCB Definition

ID: 67985726  
VAT: CZ67985726  
www.nic.cz

Note	Description
(1)	Requested Stack-Up but possible to change